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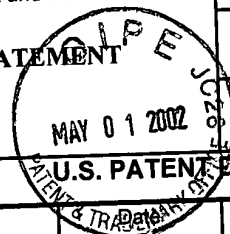
Serial No. 09/894,125

INFORMATION DISCLOSURE STATEMENT

Applicants: Shunpei YAMAZAKI et al.

Filing Date: June 29, 2001

Group Art Unit: 2823



Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date (if appropriate)
BU	5,492,843	02/20/1996	Adachi et al.			
BU	5,789,762	08/04/1998	Koyama et al.			
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OTHER DOCUMENT (Including Author, Title, Date, Pertinent Pages, Etc.)

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BU	Inventors: Shunpei YAMAZAKI et al., "Crystalline Semiconductor Thin Film, Method of Fabricating the Same, Semiconductor Device, and Method of Fabricating the Same" Filing Date: July 13, 1999, Specifications and Drawings for US Patent Application Serial No. 09/352,362
BU	Inventors: Shunpei YAMAZAKI et al., "Crystalline Semiconductor Thin Film, Method of Fabricating the Same, Semiconductor Device, and Method of Fabricating the Same" Filing Date: July 13, 1999, Specifications and Drawings for US Patent Application Serial No. 09/352,373
BU	Inventors: Ohtani HISASHI et al., "Semiconductor Device and Method of Manufacturing the Same" Filing Date: July 20, 2001, Specifications and Drawings for US Patent Application Serial No. 09/908,727

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Examiner Brook Kebede

Date Considered 11/15/2002

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

04/05/2002